

View Online at https://aerobasegroup.com/nsn/5910-01-232-4547

Body Style:	
Chip type	
Reliability Indicate	r:
Established	
Reliability Failure	Rate Level In Percent:
0.001	
Terminal Length:	
0.010 inches	
Body Length:	
0.080 inches	
Body Width:	
0.050 inches	
Body Height:	
Between 0.020 incl	es and 0.055 inches
Schematic Diagra	n Designator:
No common or grou	nded electrode (s)
Insulation Resista	nce At Maximum Operating Temp:
10000.0 megohms	
Capacitance Value	Per Section:
1000.000 picofarad	s single section
Voltage Tempurat	are Limits Per Section In Percent Capacitance Change:
-25.0/+15.0 with rat	ed voltage applied single section
Nonderated Opera	ting Temp:
Between -55.0 deg	ees celsius and 125.0 degrees celsius
Nonderated Conti	nuous Voltage Rating And Type Per Section:
100.0 dc single sec	ion
Tolerance Range	Per Section:
-10.00/+10.00 perc	ant single section
Case Material:	
Ceramic	
Insulation Resista	nce At Reference Temp:
100000.0 megohms	
Dissipation Factor	At Reference Tempurature In Percent:
2.500	
Terminal Surface	Freatment:
Palladium and silve	r
Precious Material	And Location:
Terminal surfaces p	alladium and terminal surfaces silver
Test Data Docume	nt:
81349-mil-c-55681	specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification
	ommercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain
	performance requirements and test conditions that are shown as "typical", "average", "", etc.).

Terminal Type And Quantity:

2 bonding pad



Specification Data:

81349-mil-c-55681/1 government specification

Shelf Life:

N/a

Unit Of Measure:

Demilitarization:

No

Fiig:

A010b0